

650V - 75A - IGBT

R07DS1498EJ0120 Rev.1.20 Oct.18th.2024

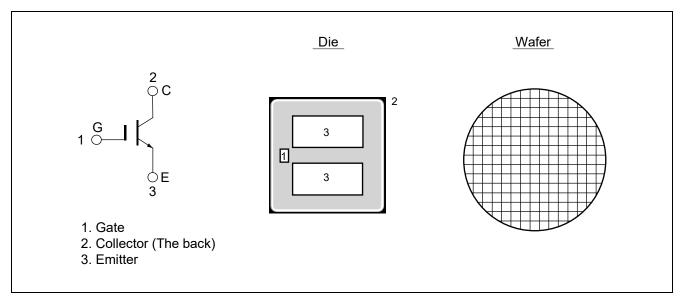
Features

- Renesas generation 8th Trench IGBT
- Low collector to emitter saturation voltage V_{CE(sat)} = 1.5 V typ. (at I_C = 75 A, V_{GE} = 15 V, Ta = 25 °C)
- High speed switching
- Applications: UPS, Welding, photovoltaic inverters, Power converter system
- Unsawn wafer Wafer size = 200 mm
- Quality grade: Standard

Key performance

Product name	V _{CES}	lc	Die size	Package
RBN75N65T1UFWA	650 V	75 A	75 A 23.04 mm ²	
			(4.80 mm x 4.80 mm)	

Outline



Mechanical parameter

Chip size	4.80 x 4.80 mm		
Area total	23.04	mm ²	
Thickness	0.075 typ.	mm	
Wafer size	193.9	mm	
Passivation frontside	Polyimide		
Pad metal	AlSi 5.5 μm		
Backside metal	Ni/Au		



Absolute Maximum Ratings

		(Tj = 25 °C unle	ss otherwise noted)
Item	Symbol	Ratings	Unit
Collector to emitter voltage	VCES	650	V
Gate to emitter voltage	Vges	±30	V
Collector current	lc	Notes1	А
Junction temperature	T _j ^{Notes2}	175 Notes2	°C

Notes: 1. Depends on thermal properties of assembly. Tj = $175 \degree C$.

2. Please use this device in the thermal conditions which the junction temperature does not exceed 175 °C.

3. Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may affect a reliability even if it is within the absolute maximum ratings. Please consider derating condition for appropriate reliability in reference Renesas Semiconductor Reliability Handbook (Recommendation for Handling and Usage of Semiconductor Devices) and individual reliability data. Especially for V_{CE} condition, recommended operating condition is set up to 80% of V_{CES} based on Renesas reliability test (HTRB) condition.

Electrical Characteristics

					(T	i = 25 °C unless otherwise noted)
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Collector to emitter leakage current	ICES			10	μA	V_{CE} = 650 V, V_{GE} = 0 V ^{Notes4}
Gate to emitter leakage current	Iges	_		±1	μA	$V_{GE} = \pm 30 \text{ V}, \text{ V}_{CE} = 0 \text{ V}^{\text{Notes4}}$
Gate to emitter threshold voltage	VGE(th)	4.1		5.9	V	V_{CE} = 10 V, Ic = 1.5 mA ^{Notes4}
Collector to emitter saturation voltage	VCE(sat)	_	1.5	2.0	V	Ic = 75 A, V _{GE} = 15 V
						Notes5, Notes6, Notes7
Input capacitance	Cies	_	1500	_	pF	V _{CE} = 25 V
Output capacitance	Coes	_	190	_	pF	V _{GE} = 0 V
Reverse transfer capacitance	Cres	_	16	_	pF	f = 1 MHz ^{Notes6, Notes7}

Notes: 4. Tested on wafer

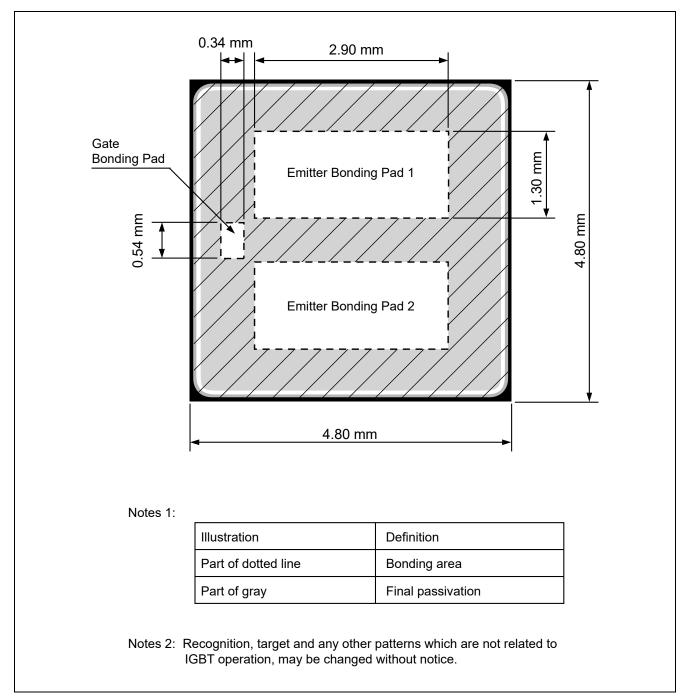
5. Pulse test

- 6. Designed target value on Renesas measurement condition. (Not tested)
- 7. Characteristic value on TO-247 package
- 8. Characteristic items prescribed in this document will guarantee the electrical characteristics in chip state but not the characteristic fluctuations or characteristic defects that occur in the processes after assembling.
- 9. Switching characteristics is depending strongly on module design and mounting technology and can therefore not be specified for a bare die.

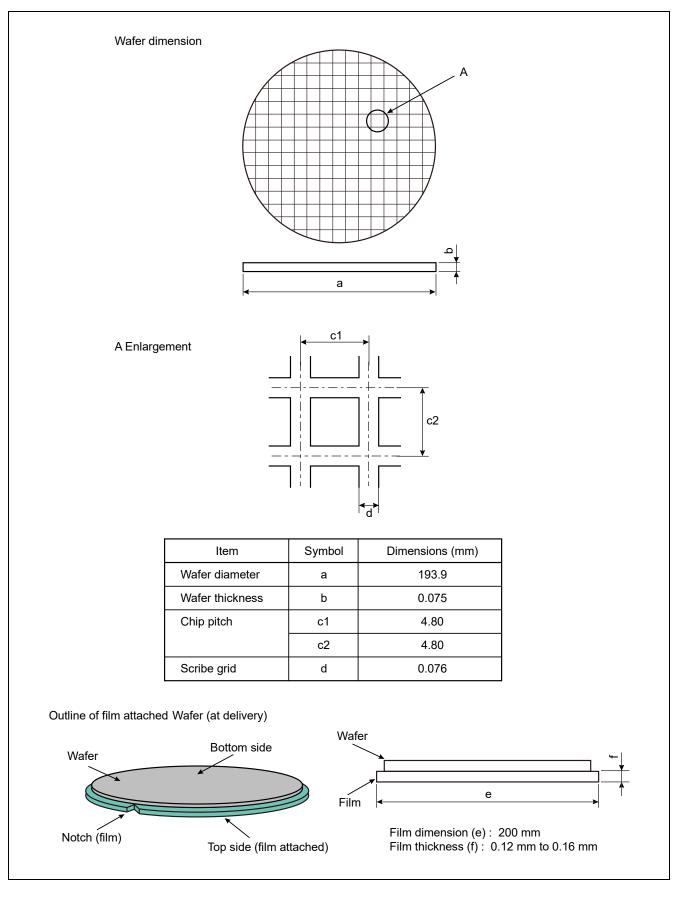
10. Please refer to "R07DS1383 RBN75H65T1FPQ-A0 Data sheet" for packaged product datasheet.



Die Dimension



Wafer Dimension



Ordering Information

Please contact your Renesas sales representative for sample requests.

Delivery Form	Ordering Part Number	Ordering Quantity Unit
Unsawn wafer	RBN75N65T1UFWA-850#FF0	5770 (5 wafers)
Unsawn wafer	RBN75N65T1UFWA-8F0#FF0	28850 (25 wafers)

Note. The order quantities indicate the maximum quantity of chips for each part number, and the actual quantity of chips shipped will be reduced due to yield. These is also a possibility that the number of wafers may decrease during the manufacturing process. The quantity shipped will be indicated on the label as the number of good chips.

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